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j1052 U.S. PTO

PATENT APPLICATION

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IN THE U.S. PATENT AND TRADEMARK OFFICE
Patent Application Transmittal Letter

COMMISSIONER FOR PATENTS
Washington, D.C. 20231

Sir:

Transmitted herewith for filing under 37 CFR 1.53 (b) is a:

(X) Utility () Design
(X) original patent application
() continuation-in-part application

INVENTOR(S): Lup San Leong

TITLE: THERMAL MECHANICAL PLANARIZATION IN INTEGRATED CIRCUITS

Enclosed are:

- (X) Declaration and Power of Attorney (X) signed () unsigned or partially signed
(X) 2 sheets of drawings (one set) () Associated Power of Attorney
() Information Disclosure Statement and Form PTO-1449 with Cited References
(X) Assignment (X) Recordation Form Cover Sheet (with duplicate copy)
(X) Priority Document(s)
() Statement Claiming Small Entity Status
(X) Acknowledgement Postcard

The filing fee has been calculated as shown below:

(1) FOR	(2) NO. FILED	(3) NO. EXTRA	(4) RATE	(5) AMOUNT
TOTAL CLAIMS	20	minus 20	0	\$ 18.00
INDEPENDENT CLAIMS	3	minus 3	0	\$ 80.00
MULTIPLE DEPENDENT CLAIM(S)				\$ 270.00
BASIC FEE:			<input checked="" type="checkbox"/> Utility; <input type="checkbox"/> Design	\$ 710.00
Total of above calculations				\$ 710.00
Assignment Recordation Fee				\$ 40.00
TOTAL FEE				\$750.00

Charge \$750.00 to Deposit Account 50-0374. At any time during the pendency of this application, please charge any fees required or credit any over payment to Deposit Account 50-0374 pursuant to CFR 1.25. Additionally please charge any fees to Deposit Account 50-0374 under 37 CFR 1.16, 1.17, 1.19, 1.20, and 1.21. A duplicate copy of this sheet is enclosed.

Correspondence Address:

Respectfully Submitted,

CUSTOMER NO. 22898

Mikio Ishimaru
Registration No. 27,449
Date: May 4, 2001